

100V N-Channel MOSFET

● Features

100V/3.1A ,

$R_{DS(ON)} < 78m\Omega @ V_{GS} = 10V$

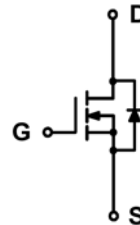
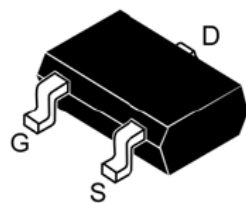
$R_{DS(ON)} < 100m\Omega @ V_{GS} = 4.5V$

Lead Free Available (RoHS Compliant)

● General Description

The FS2308T combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. this device is well suited for high current load applications.

● Pin Configuration



SOT23-3L

● Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($T_J=150^\circ\text{C}$) ^a	I_D	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	
Pulsed Drain Current ^b	I_{DM}	15	A
Avalanche Current ^b	I_{AS}	15	
Avalanche energy	E_{AS}	1.8	mJ
Power Dissipation ^a	P_D	$T_A=25^\circ\text{C}$	W
		$T_A=70^\circ\text{C}$	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^a	$R_{\theta JA}$	78	100	$^\circ\text{C/W}$
		120	150	
Maximum Junction-to-Lead	$R_{\theta JL}$	40	50	

Notes

a. Surface Mounted on 1x1FR4 Board.

b. Pulse width limited maximum junction temperature



● Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=1\text{mA}, V_{GS}=0\text{V}$	100			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=100\text{V}, V_{GS}=0$	$T_A=25^\circ\text{C}$		1	μA
			$T_A=70^\circ\text{C}$		60	
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			± 0.1	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2		4	V
$I_{D(ON)}$	On state drain current ^a	$V_{GS}=10\text{V}, V_{DS}\geq 15\text{V}$	10.8			A
$R_{DS(ON)}$	Static Drain-Source On-Resistance ^a	$V_{GS}=10\text{V}, I_D=10\text{A}$			78	$\text{m}\Omega$
		$V_{GS}=8\text{V}, I_D=10\text{A}$			100	
g_{FS}	Forward Trans conductance ^a	$V_{DS}=15\text{V}, I_D=10\text{A}$		6.5		S
V_{SD}	Diode Forward Voltage	$I_S=10\text{A}, V_{GS}=0\text{V}$	0.3		1.2	V
I_S	Maximum Body-Diode Continuous Current				1.2	A
Dynamic^b						
Q_g	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=50\text{V}, I_D=3\text{A}$		3.2		nC
Q_{gs}	Gate - Source Charge			0.45		
Q_{gd}	Gate - Drain Charge			1.6		
R_g	Gate resistance		0.5		2.5	
Switching						
$t_{D(on)}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=50\text{V}, R_L=30\Omega,$ $R_{GEN}=6\Omega, I_D=0.5\text{A}$		7	12	ns
t_r	Turn-On Rise Time			9.5	17	
$t_{D(off)}$	Turn-Off Delay Time			8	15	
t_f	Turn-Off Fall Time			10	15	
t_{rr}	Body Diode Reverse Recovery Time		$I_F=3\text{A}, dI/dt=100\text{A}/\mu\text{s}$		40	

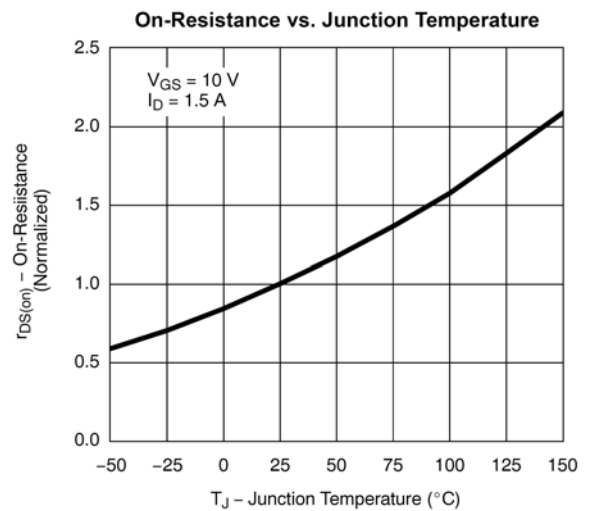
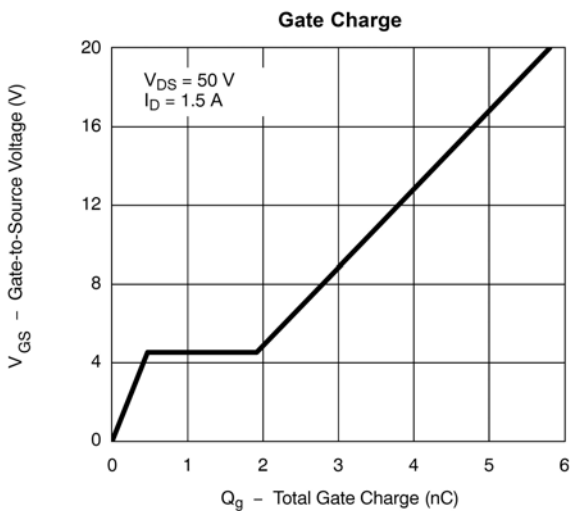
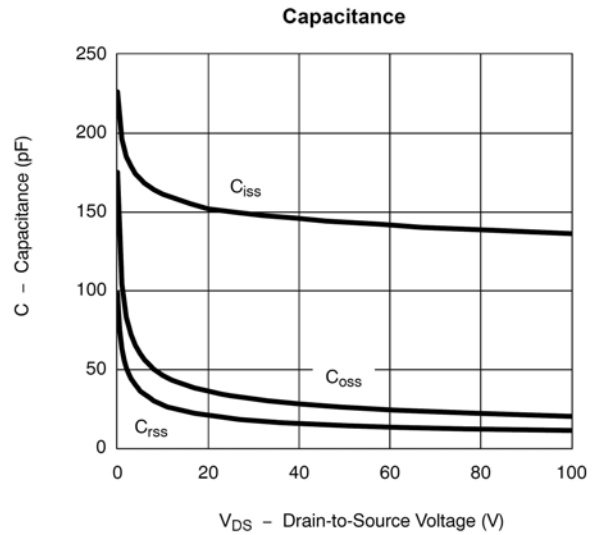
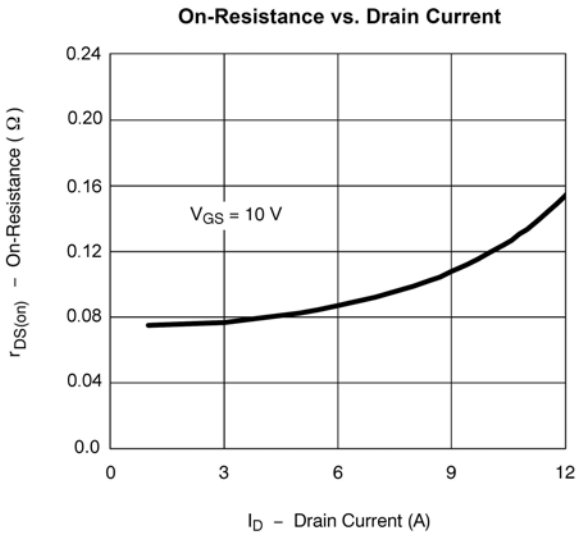
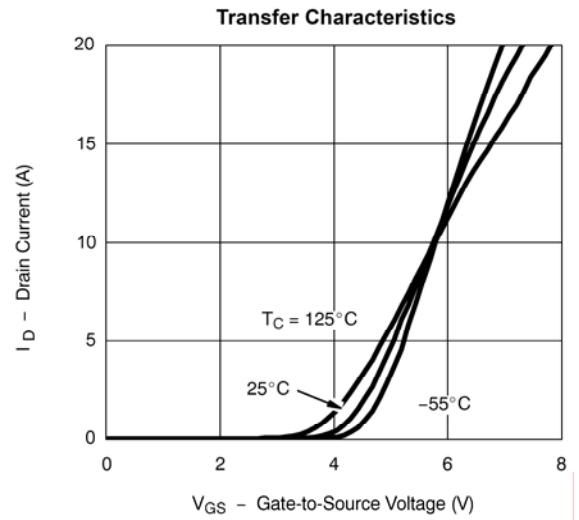
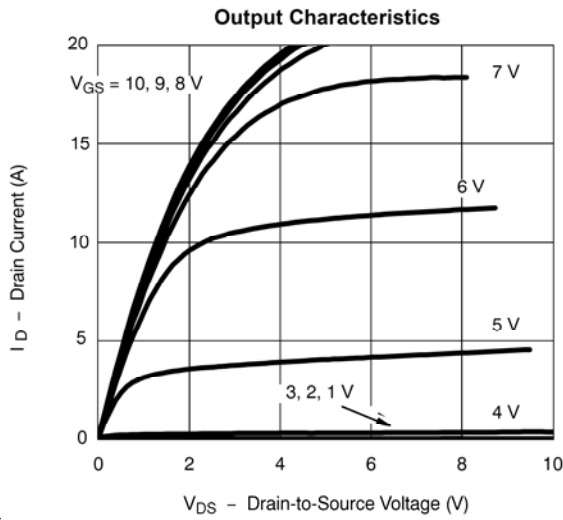
Notes

a. Pulse test: $PW \leq 300 \mu\text{s}$ duty cycle $\leq 2\%$

b. Guaranteed by design, not subject to production testing.



● TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





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